

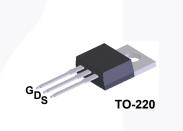
## FQP13N10 N-Channel QFET<sup>®</sup> MOSFET 100 V, 12.8 A, 180 mΩ

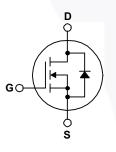
## Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

## Features

- 12.8 A, 100 V,  ${\sf R}_{{\sf DS}({\sf on})}$  = 180 m $\Omega$  (Max.) @ V\_{{\sf GS}} = 10 V,  ${\sf I}_{{\sf D}}$  = 6.4 A
- Low Gate Charge (Typ. 12 nC)
- Low Crss (Typ. 20 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating





### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

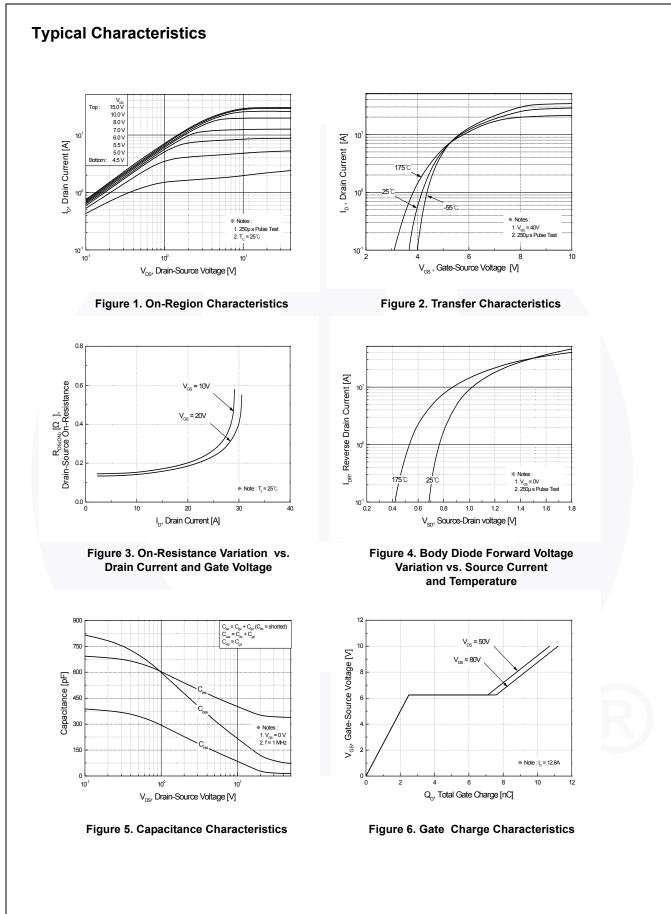
Symbol	Parameter		FQP13N10	Unit
V <sub>DSS</sub>	Drain-Source Voltage	100	V	
D	Drain Current - Continuous (T <sub>C</sub> = 25°C)	12.8	A	
	- Continuous (T <sub>C</sub> = 100°C)	_	9.05	A
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	51.2	A
V <sub>GSS</sub>	Gate-Source Voltage		± 25	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	95	mJ
AR	Avalanche Current	(Note 1)	12.8	A
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	6.5	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.0	V/ns
PD	Power Dissipation ( $T_C = 25^{\circ}C$ )		65	W
	- Derate above 25°C	0.43	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C

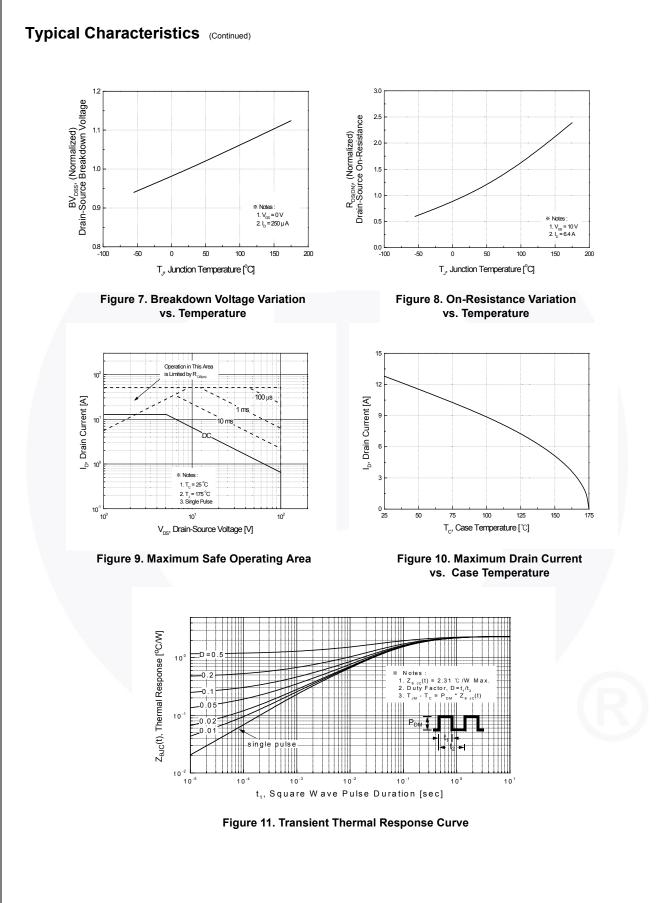
## **Thermal Characteristics**

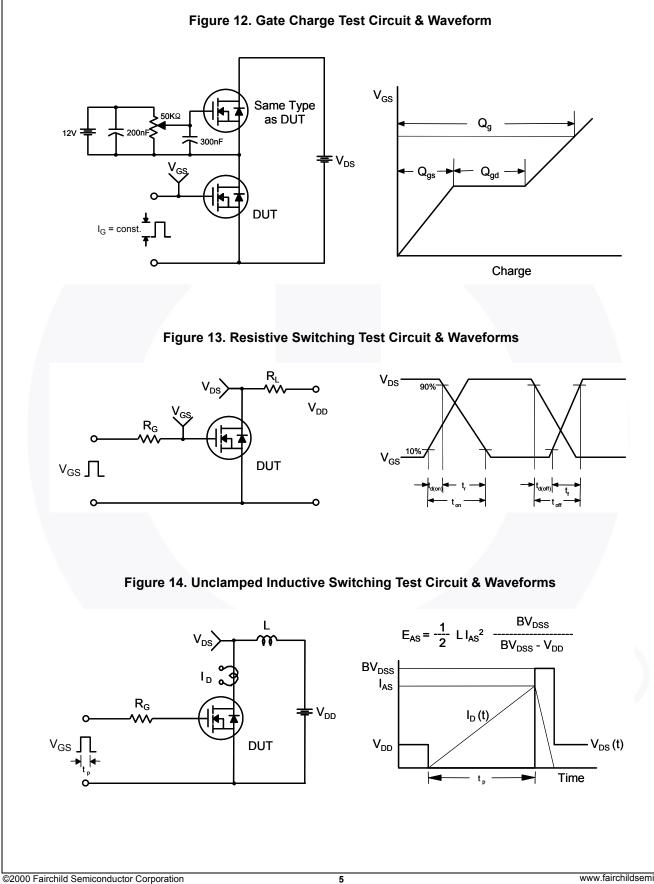
Symbol	Parameter	FQP13N10	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	2.31	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W

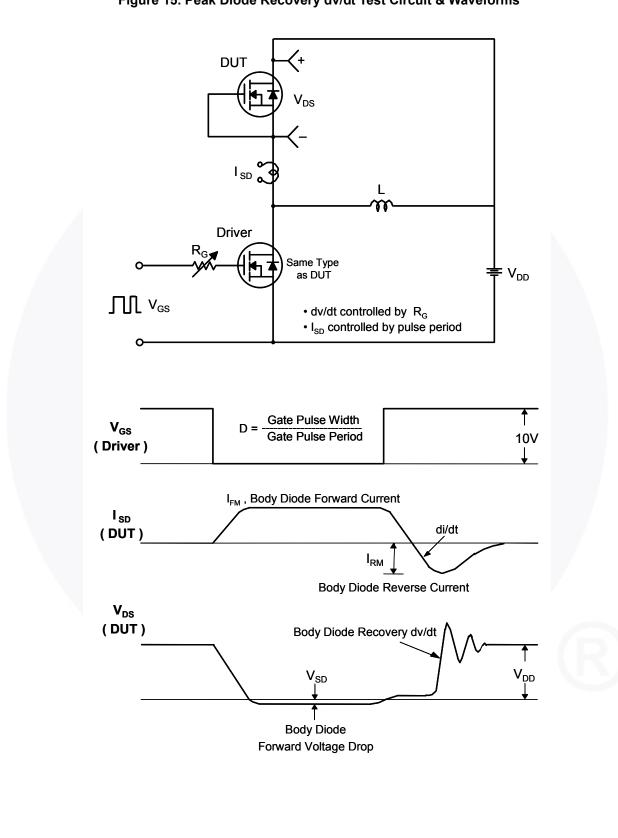
November 2013

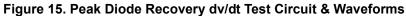
		Package	Packing Method	Reel Size	Tape Width		n Qi	Quantity	
		TO-220	Tube N/A		N/A		50 units		
lectri	cal Chara	acteristics <sub>Tc</sub>	= 25°C unless other	wise noted.					
Symbol		Parameter		Test Condit	ions	Min	Тур	Max	Unit
Off Cha	aracteristic	'S							
BV <sub>DSS</sub>		ce Breakdown Voltage		V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 J	ιA	100			V
ΔBV <sub>DSS</sub>		Voltage Temperature C	oefficient	$I_D = 250 \mu$ A, Referenced to 25°C			0.09		V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current		V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V				1	μA	
			$V_{DS} = 80 \text{ V}, \text{ T}_{C} = 150^{\circ}\text{C}$				10	μΑ	
GSSF	Gate-Body	Leakage Current, Forw	ard	V <sub>GS</sub> = 25 V, V <sub>DS</sub> = 0				100	nA
GSSR	Gate-Body	Leakage Current, Reve	rse	$V_{GS}$ = -25 V, $V_{DS}$ = 0	V			-100	nA
On Cha	racteristic	rs.							
V <sub>GS(th)</sub>	1	hold Voltage		V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250	μA	2.0		4.0	V
R <sub>DS(on)</sub>	Static Drain On-Resista			V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6.4	A		0.142	0.18	Ω
9 <sub>FS</sub>	Forward Tra	ansconductance		V <sub>DS</sub> = 40 V, I <sub>D</sub> = 6.4	A		6.8		S
-		·							
	ic Charact						0.15	450	-
Ciss	Input Capac			$V_{DS} = 25 V, V_{GS} = 0 V,$ f = 1.0 MHz			345	450	pF
C <sub>oss</sub>	Output Cap						100	130	pF
C <sub>rss</sub>	Reverse IIa	ansfer Capacitance					20	25	pF
Switchi	ing Charad	cteristics							
t <sub>d(on)</sub>	Turn-On De	lay Time		$V_{DD}$ = 50 V, I <sub>D</sub> = 12.8 A, $R_{G}$ = 25 $\Omega$ (Note 4)			5	20	ns
ŕ	Turn-On Ris	se Time					55	120	ns
t <sub>d(off)</sub>	Turn-Off De	lay Time					20	50	ns
<sup>l</sup> f	Turn-Off Fa	ll Time					25	60	ns
Qg	Total Gate (	Charge		$V_{DS}$ = 80 V, I <sub>D</sub> = 12.8 A, V <sub>GS</sub> = 10 V			12	16	nC
Q <sub>gs</sub>	Gate-Sourc	e Charge					2.5		nC
ପୁ <sub>gd</sub>	Gate-Drain	Charge			(Note 4)		5.1		nC
Drain S		de Characteristic	e and Maxi	mum Potings					
s								12.8	Α
S SM	Maximum Continuous Drain-Source Diode Forwar Maximum Pulsed Drain-Source Diode Forward Cu							51.2	A
sm / <sub>SD</sub>			V <sub>GS</sub> = 0 V, I <sub>S</sub> = 12.8	A		-	1.5	V	
rr m		covery Time	3~	$V_{GS} = 0 V, I_S = 12.8 A,$ $V_{GS} = 0 V, I_S = 12.8 A,$			72		ns
ייי גיי		covery Charge		$dI_{\rm F} / dt = 100  {\rm A}/{\rm \mu s}$	,		0.17		μC
									<b>µ</b> 0

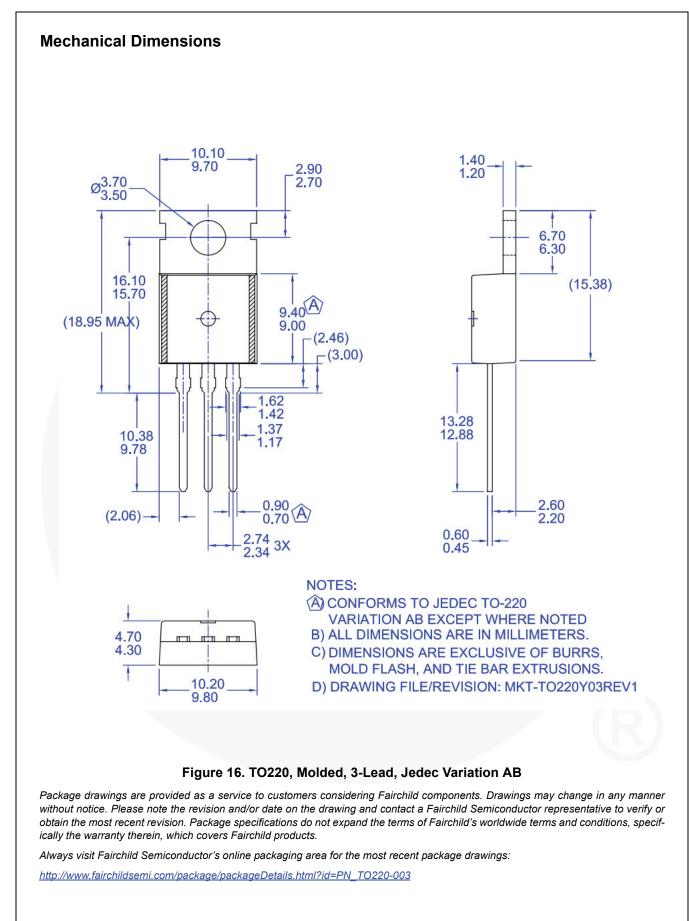














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